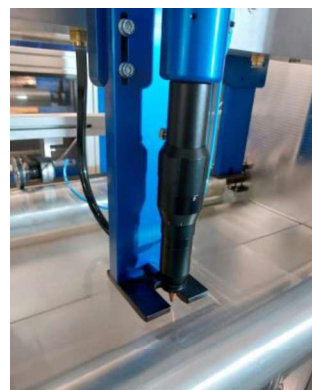


HIGH SPEED LASER FOR MICRO-HOLES & SCORING

Laser perforation is for doing micro-holes into material to allow the release of atmospheric gases from the packaging to extend the shelf life of your products (MAP) or for doing scoring, scribing in machine direction.

MOD. SM-LMH

Laser perforation for doing micro-holes into material to allow the release of atmospheric gases from the packaging to extend the shelf life of fresh products. (MAP). Our MOD. SM-LMH is typically modular and it can be mounted on just about any line. There are a non-contact method of perforating. Laser focus can be adjusted for the material being processed. It's for extending shelf life of fresh products.



Features

Max material width	3000mm
Max speed	300 meters per minute
Diameter of the holes]	from 50 my to 200 my
Installation on	bag making machine, extruder, slitter, printing machine and so on
Holes on register	Yes
Encoder to synchronize the speed	Yes
Material that could be processed	PE , PP , coated
Job memory	Yes
Operator language	Yes
User friendly software	Yes
remote assistance	Yes
Touch screen	Yes with predisposition 4.0

